Inventor: Keiji Takaoka New Divisional Application

Preliminary Amendment Filed Herewith

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claim 1-13 (Canceled)

Claim 14 (Original): An optical transmission module comprising:

a resonant-cavity light-emitting diode, said resonant-cavity light-emitting diode

including:

a substrate having a first main surface and a second main surface which are

substantially parallel to each other,

a first semiconductor distributed Bragg reflector mirror layer formed on said first main

surface of said substrate,

a semiconductor light-emitting layer formed over said first semiconductor distributed

Bragg reflector mirror layer,

a second semiconductor distributed Bragg reflector mirror layer formed over said

semiconductor light-emitting layer,

a light extraction section which is formed on said second semiconductor distributed

Bragg reflector mirror layer and has an opening to extract light from said semiconductor

light-emitting layer,

a first electrode formed around said light extraction section on said second

semiconductor distributed Bragg reflector mirror layer,

a second electrode formed on said second main surface of said substrate, and

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a reflector portion provided on an inner wall of a groove, said groove being formed by

removing portions of said first semiconductor distributed Bragg reflector mirror layer, said

semiconductor light-emitting layer and said second semiconductor distributed Bragg reflector

mirror layer which lie in a peripheral portion of said first electrode and formed to penetrate

through each of said semiconductor light-emitting layer reflector mirror layer and said second

semiconductor distributed Bragg reflector layer and reach said first semiconductor distributed

Bragg reflector mirror layer, said reflector portion being formed to reflect part of light emitted

from said semiconductor light-emitting layer into said groove; and

an optical fiber on which light from said light extraction section and groove of said

resonant-cavity light-emitting diode is incident.

Claim 15 (Original): The optical transmission module according to Claim 14, wherein

said groove of said resonant-cavity light-emitting diode is configured in substantially a ring

form and a diameter of a light-receiving end surface of said optical fiber is larger than that of

said ring of said ring-form groove.

Claim 16 (Original): The optical transmission module according to Claim 14, wherein

said reflector portion of said groove of said resonant-cavity light-emitting diode is configured

with a concave surface with respect to light from said semiconductor light-emitting layer.

Claim 17 (Original): The optical transmission module according to Claim 14, wherein

said reflector portion includes a reflection film which is formed on an inner wall portion of

said groove and reflects light from said semiconductor light-emitting layer.

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Claim 18 (Original): The optical transmission module according to Claim 14, wherein said semiconductor light-emitting layer of said resonant-cavity light-emitting diode includes an active layer using an $In_{1-x}(Ga_{1-y}A1_y)$, P-series material ($0 \le x, y \le 1$) and a light emission wavelength thereof is 620 to 690 nm.

Claim 19 (Original): The optical transmission module according to Claim 14, further comprising a high-resistance region which is formed to reach said inner wall of said groove and formed by making portions of said first semiconductor distributed Bragg reflector mirror layer and said second semiconductor distributed Bragg reflector mirror layer of said resonantcavity light-emitting diode other than at least portions thereof which lie just below said opening of said light extraction section electrically highly resistive.

Claim 20 (Original): The optical transmission module according to Claim 19, wherein each of said first semiconductor distributed Bragg reflector mirror layer and said second semiconductor distributed Bragg reflector mirror layer of said resonant-cavity light-emitting diode includes a semiconductor layer with a high A1 composition ratio and said highresistance region is formed by selectively oxidized part of said semiconductor layer in a lateral direction from said groove.

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